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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

TI-22558.2

Sadhana Gupta, et al.

Art Unit: 2624

Serial No.: 10/749,050

Examiner: Gabriel L. Garcia

Filed: December 30, 2003

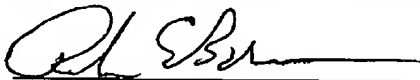
Conf. No.: 7393

For: Path to Trapezoid Decomposition of Polygons for Printing Files in a Page Description

Language

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NAME OF INVENTOR(S): Sadhana Gupta, et al.	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/749,050 Filing Date: December 30, 2003	
TITLE OF INVENTION: Path to Trapezoid Decomposition of Polygons for Printing Files in a Page Description Language	
TI FILE NO.: TI-22558.2	DEPOSIT ACCT. NO.: 20-0668
FAXED: 3/24/06 DUE: 2/28/06 ATTY/SECY: RDM/reb	

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